ASDCIATION CONNECTING ELECTRONICS INDUSTRIES® INTERNIT	C. Bannockł	ourn. Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declara he declaration	tion of the sencompass	substances es all lowe	within the er level mat	manufacture rerials for wh	er listed ite nich the ma	m. Note: i nufacture	if the item is an as r has engineering	sembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form http://www.ipc.org/IPC-175x Dist				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials					als and Mfg	ls and Mfg Information				
Supplier Information															
Company name* Comp			Company unique ID			Unique ID Authority					Response Date*				
nsemi							2024				2024-05-0	024-05-01			
Title - Contact			ct	Р			Phone - Contact*				Email - Contact*				
Product-Env-Stewards Product Env			viro Compliance			NA				Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Repres			esentative			Phone - Representative*				Email - Representative*					
Product-Env-Stewards Product Enviro			ro Compliance			NA				Product-Env-Stewards@onsemi.com					
Requester Item Number	Mfr Item Number		iber Mfr Item Name			Effective Dat	Date Version Manufacturing Site		ring Site	W	eight*	UOM	Unit Type		
	NCP128	8BD65R2G	NODSS AUTOR SOCP 65KHZ			2024-05-01			PH1		80	.48	mg	Each	
Manufacturing Proccess Informat	ion										į		·		
Terminal Plating / Grid Array Ma	Grid Array Material Terminal Base		Alloy	J-STD-020 MSL Rating		Peak Pro	Peak Process Body Temperature		re Max Time at Peak Tempera		Temperatu	e Num	ber of Reflow Cyd	eles	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260		С	30		second	3			
Comments															
evel 1 - maximum time at peak temperatu	re during so	Idering is 10-3	0 seconds												
for more information regarding material	composition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.52	mg	Supplier	Silicon (Si)	7440-21-3		2.52	mg
Die Attach	0.43	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		0.086	mg
			Supplier	Silver (Ag)	7440-22-4		0.344	mg
Lead Frame	27.82	mg	Supplier	Silver (Ag)	7440-22-4		0.1669	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0334	mg
			Supplier	Iron (Fe)	7439-89-6		0.6538	mg
			Supplier	Copper (Cu)	7440-50-8		26.9576	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0083	mg
Mold Compound-Black	48.72	mg		Epoxy resin	proprietary data		2.436	mg
			Supplier	Phenolic Resin	Proprietary Data		2.436	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.9744	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2436	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		42.63	mg
Plating	0.94	mg	Supplier	Tin (Sn)	7440-31-5		0.94	mg
Wire Bond - Cu	0.05	mg	Supplier	Copper (Cu)	7440-50-8		0.05	mg